# 2MM-R-S02-HT-01-F-TB V ACTIVE

### AMPMODU | AMPMODU 2 mm

TE Internal #: 2314928-2

PCB Mount Receptacle, Horizontal, Board-to-Board, 2 Position, 2 mm [.079 in] Centerline, Gold Flash, Through Hole - Solder, Signal,

AMPMODU 2 mm

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Connectors > PCB Connectors > PCB Headers & Receptacles











PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Horizontal
Connector System: Board-to-Board

Number of Positions: 2

Number of Rows: 1

#### **Features**

# **Product Type Features**

PCB Connector Assembly Type	PCB Mount Receptacle
Connector System	Board-to-Board
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	

Number of Loaded Positions	
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PCB Mount Orientation	Horizontal
Number of Positions	2

2

#### **Electrical Characteristics**

Number of Rows

Dielectric Withstanding Voltage (Max)	650 VAC
Operating Voltage	125 VAC

## **Body Features**

Connector Profile	Standard
Primary Product Color	Black



#### **Contact Features**

Mating Square Post Dimension	.5 mm[.02 in]
PCB Contact Termination Area Plating Material Thickness	3 – 5 μm[118.11 – 196.85 μin]
Contact Layout	Inline
Contact Underplating Material Thickness	1.27 μm[50 μin]
PCB Contact Termination Area Plating Material Finish	Matte
Contact Mating Area Plating Material Finish	Matte
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold Flash
Contact Mating Area Plating Material Thickness	.1 μm[3.94 μin]
Contact Type	Socket
Contact Current Rating (Max)	2 A

#### **Termination Features**

Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Rectangular Termination Post & Tail Width	.4 mm[.016 in]
Termination Post & Tail Length	2.1 mm[.083 in]
Termination Method to Printed Circuit Board	Through Hole - Solder

### Mechanical Attachment

Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount

# **Housing Features**

Centerline (Pitch)	2 mm[.079 in]
Housing Material	LCP (Liquid Crystal Polymer)

# Dimensions

Connector Length	4 mm[.158 in]
Connector Height	2.1 mm[.823 in]
Connector Width	4.7 mm[.185 in]
PCB Thickness (Recommended)	1.6 mm[.063 in]



#### **Usage Conditions**

Housing Temperature Rating	High
Operating Temperature Range	-40 - 125 °C[-40 - 257 °F]
Operation/Application	
Assembly Process Feature	Pick and Place Cover
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	

Tube

## **Product Compliance**

Packaging Type

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**

PCB Mount Receptacle, Horizontal, Board-to-Board, 2 Position, 2 mm [.079 in] Centerline, Gold Flash, Through Hole - Solder, Signal, AMPMODU 2 mm





TE Part # 2355045-2 2P,2MM,BRK HDR,SRVT,2.8,0.1AU,TB





# Also in the Series | AMPMODU 2 mm



Connector Contacts(27)



PCB Headers & Receptacles(10407)

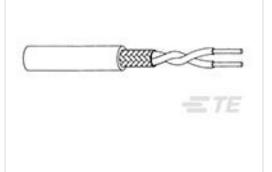


Wire-to-Board Connector Assemblies & Housings(202)

# Customers Also Bought



TE Part #4-2176058-2 RLP73K 3A R51 5% 2K RL



TE Part #090695-000 0026A0024-9X



TE Part #1-329632-2 LOCKWASHER, PLATED



TE Part #120956-1 UPM EXPANDED PIN ASSEMBLY



TE Part #2307725-2 2P,2MM,B-B,REC,SRHZ,SMD,0.1AU



TE Part #2314876-2 2P,2MM,BB,REC,SRVT,2.7,0.1AU,TUBE



TE Part #2314936-6 6P,2MM,B-B,REC,SRHZ,2.8,0.1AU,TR



TE Part #2314876-4

4P,2MM,B-B,REC,SRVT,2.7,0.1AU,TB

TE Part #322374-1 DIAMOND GRIP 16-14 HR AU R 8

PCB Mount Receptacle, Horizontal, Board-to-Board, 2 Position, 2 mm [.079 in] Centerline, Gold Flash, Through Hole - Solder, Signal, AMPMODU 2 mm



### **Documents**

**CAD Files** 

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_2314928-2\_A.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2314928-2\_A.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2314928-2\_A.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

## Datasheets & Catalog Pages

AMPMODU 2mm BOARD-TO-BOARD RECEPTACLES

English

AMPMODU 2mm interconnection system QRG

English

# **Product Specifications**

**Application Specification** 

English